L Number	Hits	Search Text	DB	Time stamp
-	393	(385/18).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/28 16:30
-	2454	mems or microelectromechanical	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/18 15:54
-	1038	(mems or microelectromechanical) and (flap or plate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/18 15:54
-	428	((mems or microelectromechanical) and (flap or plate)) and base	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/18 15:54
-	190	(((mems or microelectromechanical) and (flap or plate)) and base) and electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/18 15:55
-	0	(((mems or microelectromechanical) and (flap or plate)) and base) and (sidewall adj electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/18 15:55
-	27	(((mems or microelectromechanical) and (flap or plate)) and base) and sidewall and electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/18 15:55
-	883	385/17	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/28 16:31
-	45	385/17 and mems	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/01 08:05
-	49	385/17 and (mems or microelectromechanical)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/01 09:59
-	63	385/18 and (mems or microelectromechanical)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/01 13:09
-	14	359/872 and (mems or microelectromechanical)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/01 13:19
-	1	359/876 and (mems or microelectromechanical)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/04/01 13:20

| | | 2 | 359/877 and (mems or microelectromechanical) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/04/01 13:23 |
| - | | 1 | ("6360036").PN. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/04/01 13:23 |